

Beam Power Tube

CERAMIC-METAL SEALS
UNIPOTENTIAL CATHODE
CONDUCTION COOLED

COAXIAL-ELECTRODE STRUCTURE
INTEGRAL CONDUCTION CYLINDER
180 WATTS CW INPUT UP TO 1215 Mc

For Use at Frequencies up to 2000 Mc

GENERAL DATA

Electrical:

Heater, for Unipotential Cathode:

Voltage (AC or DC)▲	6.3 ± 10%	volts
Current at heater volts = 6.3	2.1	amp
Minimum heating time.	60	sec

Mu-Factor, Grid No.2 to Grid No.1

for plate volts = 250, grid-No.2

volts = 250, and plate ma. = 100. 18

Direct Interelectrode Capacitances:●

Grid No.1 to plate.	0.065 max.	μμf
Grid No.1 to cathode & heater	14	μμf
Plate to cathode & heater	0.015 max.	μμf
Grid No.1 to grid No.2.	17	μμf ←
Grid No.2 to plate.	4.4	μμf
Grid No.2 to cathode & heater	0.4 max.	μμf

Mechanical:

Operating Position. Any

Overall Length. 1.885" +0.070" -0.080"

Greatest Diameter (See *Dimensional Outline*) 1.119"

Weight (Approx.). 2 oz

Socket:

For frequencies up to about 400 Mc. ★

For use at higher frequencies . . . See *Mounting Arrangement*

Terminal Connections (See *Dimensional Outline*):

G₁ - Grid-No.1-
Terminal

Contact

Surface

G₂ - Grid-No.2-
Terminal

Contact

Surface

H - Heater-
Terminal

Contact

Surface

H, K - Heater- &
Cathode-

Terminal

Contact

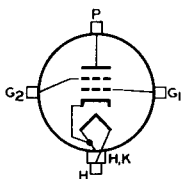
Surface

P - Plate-

Terminal

Contact

Surface



Thermal:

Conduction-Cylinder Temperature 250 max. °C

Seal Temperature (Plate, Grid No.2,

Grid No.1, Cathode, and Heater) 250 max. °C

Cooling, Conduction:

The conduction cylinder must be thermally coupled to a constant-temperature device (heat sink—solid or liquid) to limit the conduction cylinder to the specified maximum

← Indicates a change.



value of 250° C. The plate, grid-No.2, grid-No.1, cathode, and heater terminals may also require coupling to the heat sink to limit their respective seal temperature to the specified maximum value of 250° C.

AF POWER AMPLIFIER & MODULATOR — Class AB₁

Maximum CCS Ratings, Absolute-Maximum Values:

DC PLATE VOLTAGE.	1000 max.	volts
DC GRID-No.2 VOLTAGE.	300 max.	volts
MAX.—SIGNAL DC PLATE CURRENT.	180 max.	ma
MAX.—SIGNAL PLATE INPUT.	180 max.	watts
MAX.—SIGNAL GRID-No.2 INPUT.	7 max.	watts
PLATE DISSIPATION.		

Typical CCS Push-Pull Operation:

Values are for 2 tubes

DC Plate Voltage.	650	850	volts
DC Grid-No.2 Voltage.	300	300	volts
DC Grid-No.1 Voltage from fixed-bias source.	-15	-15	volts
Peak AF Grid-No.1-to-Grid-No.1 Voltage.	30	30	volts
Zero-Signal DC Plate Current.	80	80	ma
Max.—Signal DC Plate Current.	200	200	ma
Zero-Signal DC Grid-No.2 Current.	0	0	ma
Max.—Signal DC Grid-No.2 Current.	20	20	ma
Effective Load Resistance (Plate to plate).	4330	7000	ohms
Max.—Signal Driving Power (Approx.)	0	0	watts
Max.—Signal Power Output (Approx.)	50	80	watts

Maximum Circuit Values:

Grid-No.1—Circuit Resistance under any condition.*

For fixed-bias operation.	30000 max.	ohms
For cathode-bias operation.	Not recommended	

AF POWER AMPLIFIER & MODULATOR — Class AB₂

Maximum CCS Ratings, Absolute-Maximum Values:

DC PLATE VOLTAGE.	1000 max.	volts
DC GRID-No.2 VOLTAGE.	300 max.	volts
MAX.—SIGNAL DC PLATE CURRENT.	180 max.	ma
MAX.—SIGNAL DC GRID-No.1 CURRENT.	30 max.	ma
MAX.—SIGNAL PLATE INPUT.	180 max.	watts
MAX.—SIGNAL GRID-No.2 INPUT.	7 max.	watts
PLATE DISSIPATION.		

Typical CCS Push-Pull Operation:

Values are for 2 tubes

DC Plate Voltage.	650	850	volts
DC Grid-No.2 Voltage.	300	300	volts
DC Grid-No.1 Voltage from fixed-bias source.	-15	-15	volts
Peak AF Grid-No.1-to-Grid-No.1 Voltage.	46	46	volts
Zero-Signal DC Plate Current.	80	80	ma
Max.—Signal DC Plate Current.	355	355	ma
Zero-Signal DC Grid-No.2 Current.	0	0	ma

Max.-Signal DC Grid-No.2 Current.	25	25	ma
Max.-Signal DC Grid-No.1 Current.	15	15	ma
Effective Load Resistance (Plate to plate). . .	2450	3960	ohms
Max.-Signal Driving Power (Approx.)†. . . .	0.3	0.3	watt
Max.-Signal Power Output (Approx.).	85	140	watts

LINEAR RF POWER AMPLIFIER

Single-Sideband Suppressed-Carrier Service

Maximum CCS¹ Ratings, Absolute-Maximum Values:

Up to 1215 Mc

DC PLATE VOLTAGE.	1000 max.	volts
DC GRID-No.2 VOLTAGE.	300 max.	volts
MAX.-SIGNAL DC PLATE CURRENT.	180 max.	ma
MAX.-SIGNAL DC GRID-No.1 CURRENT.	30 max.	ma
MAX.-SIGNAL PLATE INPUT	180 max.	watts
MAX.-SIGNAL GRID-No.2 INPUT	7 max.	watts
PLATE DISSIPATION	♣	

Typical CCS Class AB₁ "Single-Tone" Operation:

Up to 60 Mc

DC Plate Voltage.	650	850	volts
DC Grid-No.2 Voltage [®]	300	300	volts
DC Grid-No.1 Voltage.	-15	-15	volts
Zero-Signal DC Plate Current.	40	40	ma
Zero-Signal DC Grid-No.2 Current.	0	0	ma
Effective RF Load Resistance.	2165	3500	ohms
Max.-Signal DC Plate Current.	100	100	ma
Max.-Signal DC Grid-No.2 Current.	10	10	ma
Max.-Signal DC Grid-No.1 Current.	0	0	ma
Max.-Signal Peak RF Grid-No.1 Voltage . . .	15	15	volts
Max.-Signal Driving Power (Approx.)	0	0	watts
Max.-Signal Power Output (Approx.).	25	40	watts

Maximum Circuit Values:

Grid-No.1-Circuit Resistance under any condition:

For fixed-bias operation.	30000 max.	ohms
For cathode-bias operation.	Not recommended	

PLATE-MODULATED RF POWER AMPLIFIER — Class C Telephony

*Carrier conditions per tube for use
with a maximum modulation factor of 1*

Maximum CCS¹ Ratings, Absolute-Maximum Values:

Up to 1215 Mc

DC PLATE VOLTAGE.	800 max.	volts
DC GRID-No.2 VOLTAGE.	300 max.	volts
DC GRID-No.1 VOLTAGE.	-100 max.	volts
DC PLATE CURRENT.	150 max.	ma
DC GRID-No.1 CURRENT.	30 max.	ma
PLATE INPUT	120 max.	watts
GRID-No.2 INPUT	4.6 max.	watts
PLATE DISSIPATION	♣	



Typical CCS Operation:

	At 400 Mc	
DC Plate Voltage.	400	700 volts
DC Grid-No.2 Voltage [§]	200	250 volts
DC Grid-No.1 Voltage [□]	-20	-50 volts
DC Plate Current.	100	130 ma
DC Grid-No.2 Current.	5	10 ma
DC Grid-No.1 Current.	5	10 ma
Driver Power Output (Approx.) [◇]	2	3 watts
Useful Power Output (Approx.)	16	45 watts

Maximum Circuit Values:

Grid-No.1-Circuit Resistance under
any condition 30000[▽] max. ohms

**RF POWER AMPLIFIER & OSCILLATOR — Class C Telegraphy^{▲▲}
and**

RF POWER AMPLIFIER — Class C FM Telephony

Maximum CCS[↓] Ratings, Absolute-Maximum Values:

	Up to 1215 Mc	
DC PLATE VOLTAGE.	1000 max.	volts
DC GRID-No.2 VOLTAGE.	300 max.	volts
DC GRID-No.1 VOLTAGE.	-100 max.	volts
DC PLATE CURRENT.	180 max.	ma
DC GRID-No.1 CURRENT.	30 max.	ma
PLATE INPUT	180 max.	watts
GRID-No.2 INPUT	7 max.	watts
PLATE DISSIPATION	4 ⁺	

Typical CCS Operation:

	At 400 Mc	At 1215 Mc	
DC Plate Voltage.	400	900	volts
DC Grid-No.2 Voltage ^{●●}	200	300	volts
DC Grid-No.1 Voltage ^{★★}	-35	-30	volts
DC Plate Current.	150	170	ma
DC Grid-No.2 Current.	5	1	ma
DC Grid-No.1 Current.	3	10	ma
Driver Power Output (Approx.) [◇]	3	3	watts
Useful Power Output (Approx.)	23	80	watts

Maximum Circuit Values:

Grid-No.1-Circuit Resistance under
any condition 30000[▽] max. ohms

▲ Because the cathode is subjected to considerable back bombardment as the frequency is increased with resultant increase in temperature, the heater voltage should be reduced depending on operating conditions and frequency to prevent overheating the cathode and resultant short life.

● Measured with special shield adapter.

★ For socket to be used with the 7844, consult manufacturers such as J-V-M Microwave Company, 9300 West 47th Street, Brookfield, Illinois; E.F. Johnson Company, Waseca, Minnesota; and Collins Radio Company, 655 35th Street North, Cedar Rapids, Iowa; and Jettron Products, Route 10, Hanover, New Jersey.

◇ Subscript 1 indicates that grid-No.1 current does not flow during any part of the input cycle.

- Continuous Commercial Service.
- Averaged over any audio-frequency cycle of sine-wave form.
- Maximum plate dissipation is a function of the maximum plate input, efficiency of the class of service, and the effectiveness of the cooling system. See *Cooling, Conduction* under *General Data*, and also *Cooling Considerations*.
- Preferably obtained from a fixed supply.
- # The driver stage should be capable of supplying the No.1 grids of the Class AB₁ stage with the specified driving voltage at low distortion.
- * The resistance introduced into the grid-No.1 circuit by the input coupling should be held to a low value. In no case should it exceed the specified maximum value. Transformer- or impedance-coupling devices are recommended.
- Subscript 2 indicates that grid-No.1 current flows during some part of the input cycle.
- † Driver stage should be capable of supplying the specified driving power at low distortion to the No.1 grids of the AB₂ stage. To minimize distortion, the effective resistance per grid-No.1 circuit of the AB₂ stage should be held at a low value. For this purpose, the use of transformer coupling is recommended.
- ‡ "Single-Tone" operation refers to that class of amplifier service in which the grid-No.1 input consists of a monofrequency rf signal having constant amplitude. This signal is produced in a single-sideband suppressed-carrier system when a single audio frequency of constant amplitude is applied to the input of the system.
- § Obtained preferably from a separate source modulated along with the plate supply.
- Obtained from grid-No.1 resistor or from a combination of grid-No.1 resistor with either fixed supply or cathode resistor.
- ◇ The driver stage is required to supply tube losses and rf-circuit losses. It should be designed to provide an excess of power above the indicated values to take care of variations in line voltage, components, initial tube characteristics, and tube characteristics during life.
- ♥ If this value is insufficient to provide adequate bias, the additional required bias must be supplied by a cathode resistor or fixed supply.
- ▲▲ Key-down conditions per tube without amplitude modulation. Amplitude modulation essentially negative may be used if the positive peak of the audio frequency envelope does not exceed 115 per cent of the carrier conditions.
- Obtained preferably from a fixed supply, or from the plate supply voltage with a voltage divider.
- ★ Obtained from fixed supply, by grid-No.1 resistor, by cathode resistor, or by combination methods.

CHARACTERISTICS RANGE VALUES FOR EQUIPMENT DESIGN

	Note	Min.	Max.	
Heater Current.	1	1.84	2.26	amp
Direct Interelectrode Capacitances:				
Grid No.1 to plate.	2	-	0.065	μf
Grid No.1 to cathode & heater.	2	11.8	15.2	μf
Plate to cathode & heater.	2	-	0.015	μf
Grid No.1 to grid No.2.	2	15.9	18.9	μf ←
Grid No.2 to plate.	2	4	5	μf
Grid No.2 to cathode & heater.	2	-	0.4	μf
Grid-No.1 Voltage.	1,3	-6	-15	volts ←
Grid-No.1 Cutoff Voltage.	1,4	-	-30	volts
Grid-No.1 Current.	1,5	10	-	ma
Reverse Grid-No.1 Current.	1,3	-	-20	μa
Grid-No.2 Current.	1,3	-8	+2	ma
Peak Emission Voltage.	1,6	-	400	volts
Interelectrode Leakage Resistance.	7	1	-	megohm
Useful Power Output.	8	80	-	watts

← Indicates a change.



- Note 1: With 6.3 volts ac or dc on heater.
- Note 2: Measured with special shield adapter.
- Note 3: With dc plate voltage of 1000 volts, dc grid-No.2 voltage of 300 volts, and dc grid-No.1 voltage adjusted to give a dc plate current of 115 ma.
- Note 4: With dc plate voltage of 1000 volts, dc grid-No.2 voltage of 250 volts, and dc grid-No.1 voltage adjusted to give a dc plate current of 1 ma.
- Note 5: With plate and grid-No.2 floating and dc grid-No.1 voltage of +2 volts.
- Note 6: For conditions with: grid No.1, grid No.2, and plate tied together; and pulse-voltage source connected between plate and cathode. Pulse duration is 2 microseconds, pulse-repetition frequency is 60 pps, and duty factor is 0.00012. The voltage-pulse amplitude is adjusted until a peak cathode current of 10 amperes is obtained. After 1 minute at this value, the voltage-pulse amplitude will not exceed 400 volts (peak).
- Note 7: Under conditions with tube at 20° to 30° C for at least 30 minutes without any voltages applied to the tube. The minimum resistance between any two adjacent electrodes as measured with a 200-volt Megger-type ohmmeter having an internal impedance of 1 megohm, will be 1 megohm.
- Note 8: In a single-tube, grid-driven, coaxial-cavity class-C-amplifier circuit at 400 Mc and for conditions with 5.7 volts ac or dc on heater, dc plate voltage of 100 volts, dc grid-No.2 voltage of 300 volts, grid-No.1 resistor adjustable between 1000 and 10,000 ohms, dc plate current of 180 ma. maximum, dc grid-No.1 current of 20 ma. maximum, and driver power output of 3 watts.

COOLING CONSIDERATIONS

The conduction-cooling system consists, in general, of a constant-temperature device (heat sink) and suitable heat-flow path (coupling) between the heat sink and tube. Careful consideration should be given to the design of a heat-flow path through a coupling device having low electrical conductivity and high thermal conductivity.

The maximum plate dissipation may be calculated from the equation:

$$W = KA \frac{(T_2 - T_1)}{L}$$

where:

W = maximum plate dissipation in watts

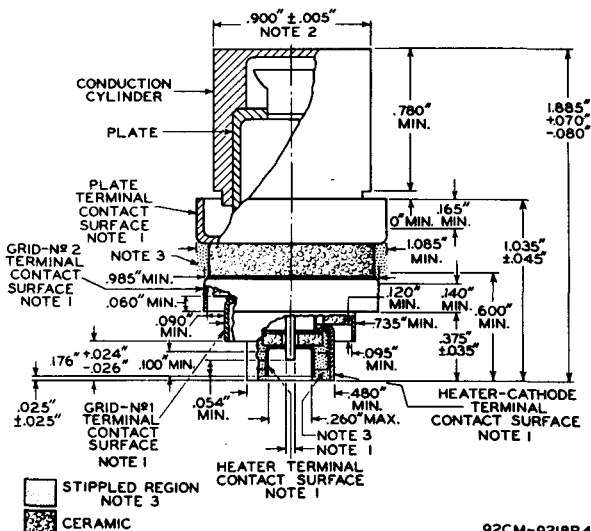
K = thermal conductivity♦♦ of the coupling material

A = area measured at right angles to the direction of the flow of heat in square inches

T₂, T₁ = temperature in degrees Centigrade of planes or surfaces under consideration

L = length of heat path in inches through coupling material to produce temperature gradient

♦♦ Thermal conductivity is defined as the time rate of transfer of heat by conduction, through unit thickness, across unit area for unit difference of temperature. It is measured in watts per square inch for a thickness of one inch and a difference of temperature of 1° C.



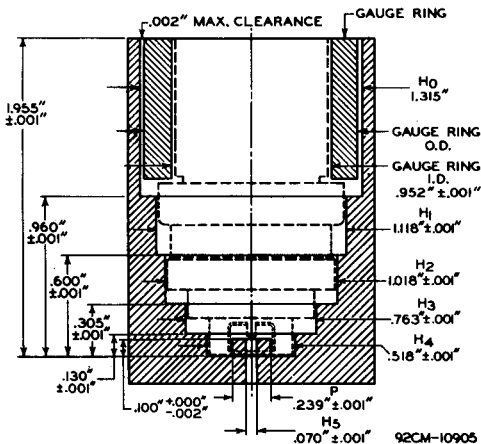
92CM-9218R4

NOTE 1: WITH THE CYLINDRICAL SURFACES OF THE PLATE TERMINAL, GRID-No. 2 TERMINAL, GRID-No. 1 TERMINAL, HEATER-CATHODE TERMINAL, AND HEATER TERMINAL CLEAN, SMOOTH, AND FREE OF BURRS, THE TUBE WILL ENTER A GAUGE AS SHOWN IN SKETCH G_1 . THE TUBE IS PROPERLY SEATED IN THE GAUGE WHEN A 0.010"-THICKNESS GAUGE 1/8" WIDE WILL NOT ENTER BETWEEN THE HEATER-CATHODE TERMINAL AND THE BOTTOM SURFACE OF H_4 . THE GAUGE IS PROVIDED WITH A SLOT TO PERMIT MAKING MEASUREMENT OF SEATING OF HEATER-CATHODE TERMINAL ON BOTTOM OF HOLE H_4 .

NOTE 2: WITH THE TUBE SEATED IN GAUGE AND WITH THE CONDUCTION CYLINDER CLEAN, SMOOTH, AND FREE OF BURRS, THE GAUGE RING WILL SLIP OVER CONDUCTION CYLINDER AS SHOWN IN SKETCH G_1 .

NOTE 3: KEEP ALL STIPPLED REGIONS CLEAR. DO NOT ALLOW CONTACTS OR CIRCUIT COMPONENTS TO PROTRUDE INTO THESE ANNULAR VOLUMES.

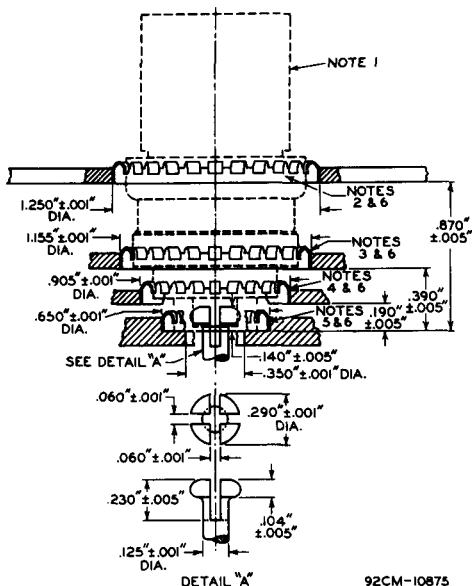


SKETCH G₁

THE AXES OF THE CYLINDRICAL HOLES H₁ THROUGH H₅ AND THE AXIS OF POST P ARE COINCIDENT WITHIN 0.001".

THE AXES OF THE GAUGE-RING INSIDE DIAMETER AND GAUGE-RING OUTSIDE DIAMETER ARE COINCIDENT WITHIN 0.001".

SUGGESTED MOUNTING ARRANGEMENT & LAYOUT OF ASSOCIATED CONTACTS



NOTE 1: IF A CLAMP IS USED, IT MUST BE ADJUSTABLE IN A PLANE NORMAL TO THE MAJOR TUBE AXIS TO COMPENSATE FOR VARIATIONS IN CONCENTRICITY BETWEEN THE CONDUCTION CYLINDER AND THE CONTACT TERMINALS.

NOTE 2: CONTACT RING No. 97-252 OR FINGER STOCK No. 97-380.

NOTE 3: CONTACT RING No. 97-253 OR FINGER STOCK No. 97-380.

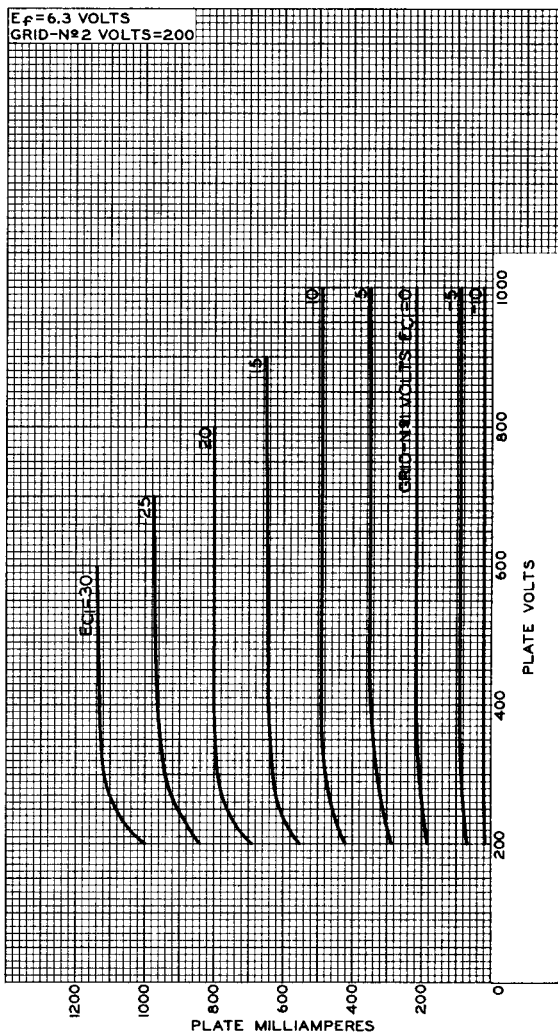
NOTE 4: CONTACT RING No. 97-254 OR FINGER STOCK No. 97-380.

NOTE 5: CONTACT RING No. 97-255 OR FINGER STOCK No. 97-380.

NOTE 6: THE SPECIFIED CONTACT RING OF PREFORMED FINGER STOCK AND FINGER STOCK No. 97-380 PROVIDE ADEQUATE ELECTRICAL CONTACT, BUT THE FINGER STOCK No. 97-380 IS LESS SUSCEPTIBLE TO BREAKAGE THAN THE SPECIFIED CONTACT RING. BOTH TYPES ARE MADE BY INSTRUMENTS SPECIALTIES COMPANY, LITTLE FALLS, NEW JERSEY.

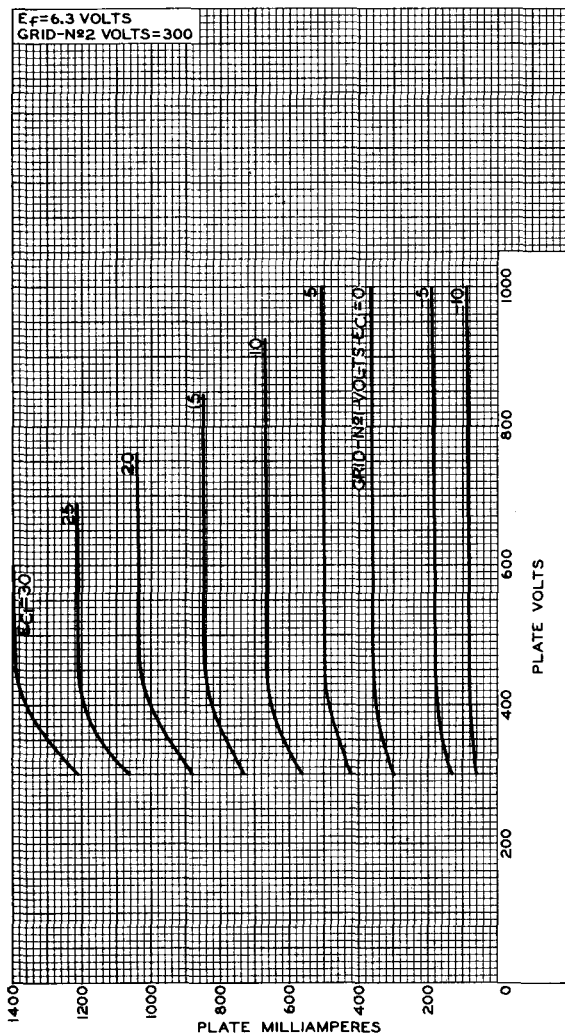


TYPICAL PLATE CHARACTERISTICS



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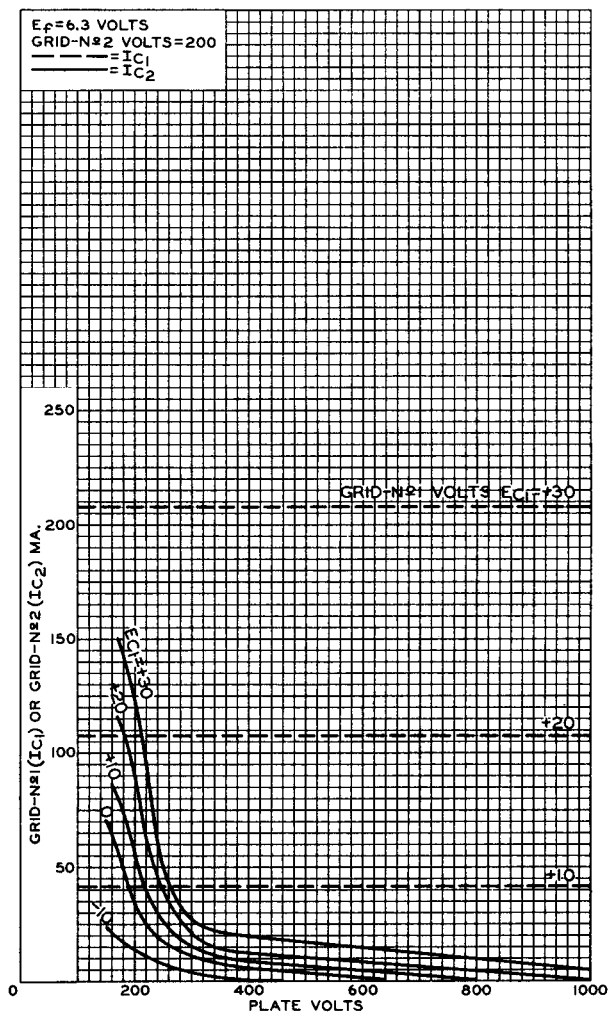
TYPICAL PLATE CHARACTERISTICS



92CM-9222RI



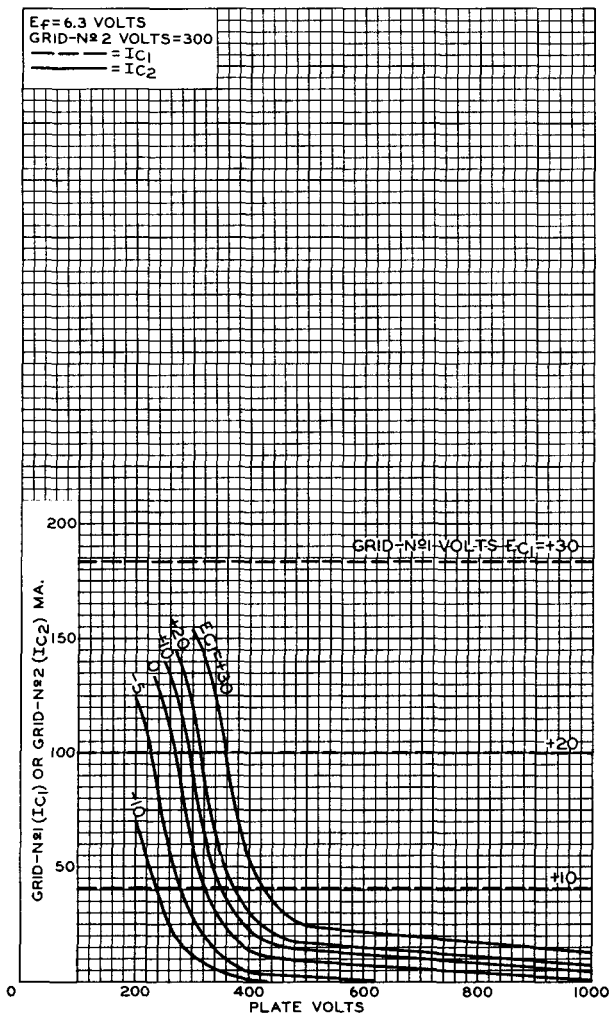
TYPICAL CHARACTERISTICS



92CM-9224R1



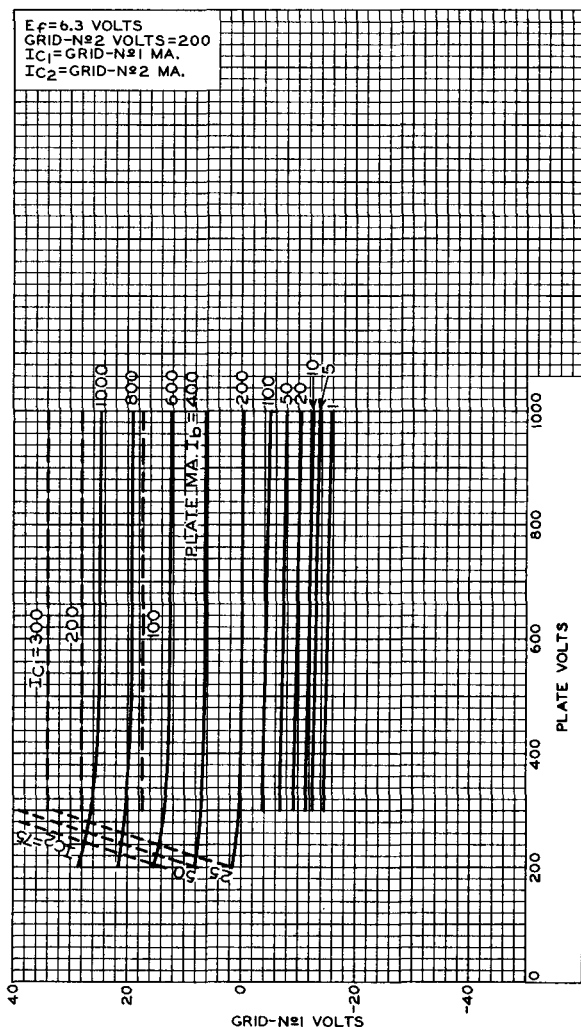
TYPICAL CHARACTERISTICS



92CM-9225R2



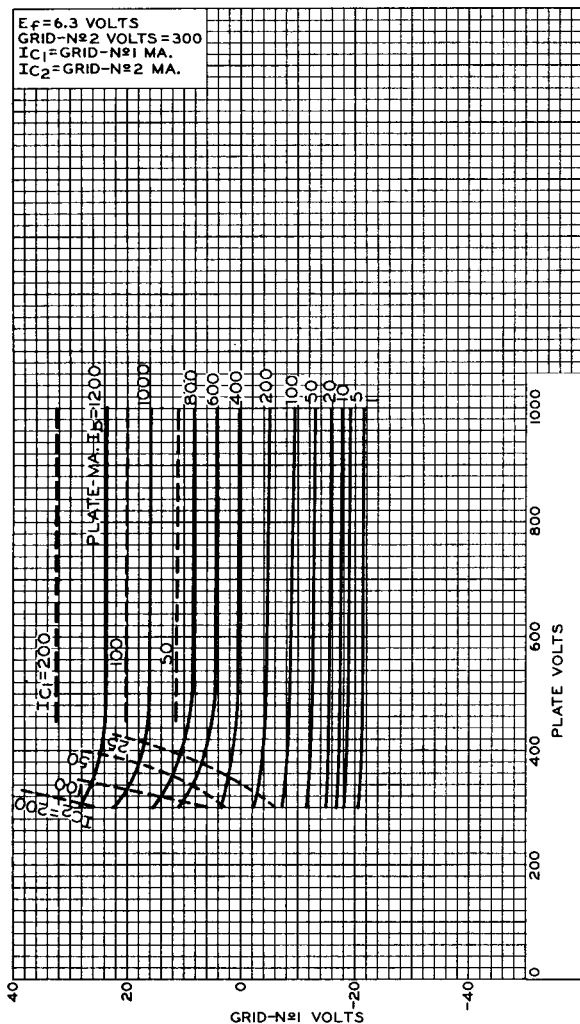
TYPICAL CONSTANT-CURRENT CHARACTERISTICS



92CM-9233RI



TYPICAL CONSTANT-CURRENT CHARACTERISTICS



92CM-9232RI



TYPICAL PERFORMANCE CHARACTERISTICS

In Class C Telegraphy or Class C FM Telephony Amplifier Service

E_f = ADJUSTED TO SIMULATE NORMAL OPERATING
CONDITIONS OF HEATER IN UHF SERVICE

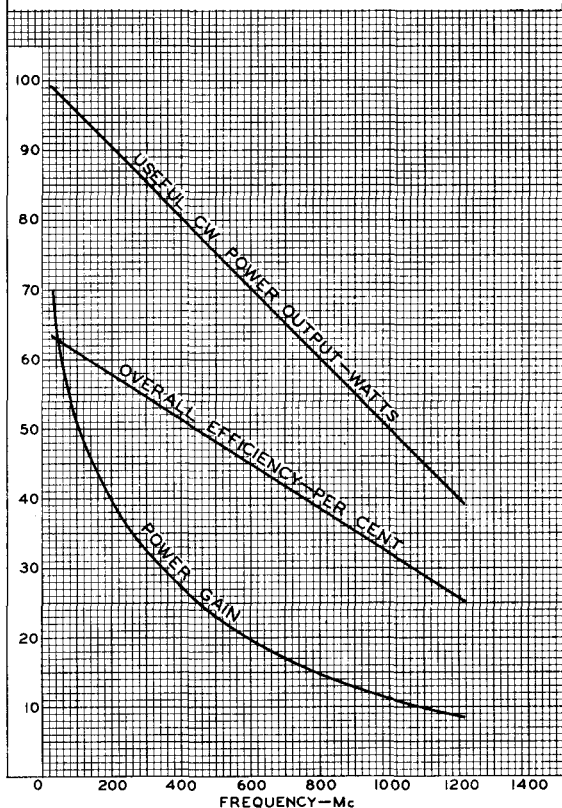
PLATE VOLTS = 900

GRID- $N \pm 2$ VOLTS = 300

PLATE AMPERES = 0.170

OVERALL EFFICIENCY = USEFUL POWER OUTPUT IN LOAD
DIVIDED BY DC PLATE INPUT

POWER GAIN = USEFUL POWER OUTPUT IN LOAD
DIVIDED BY DRIVER POWER OUTPUT



92CM-9221

